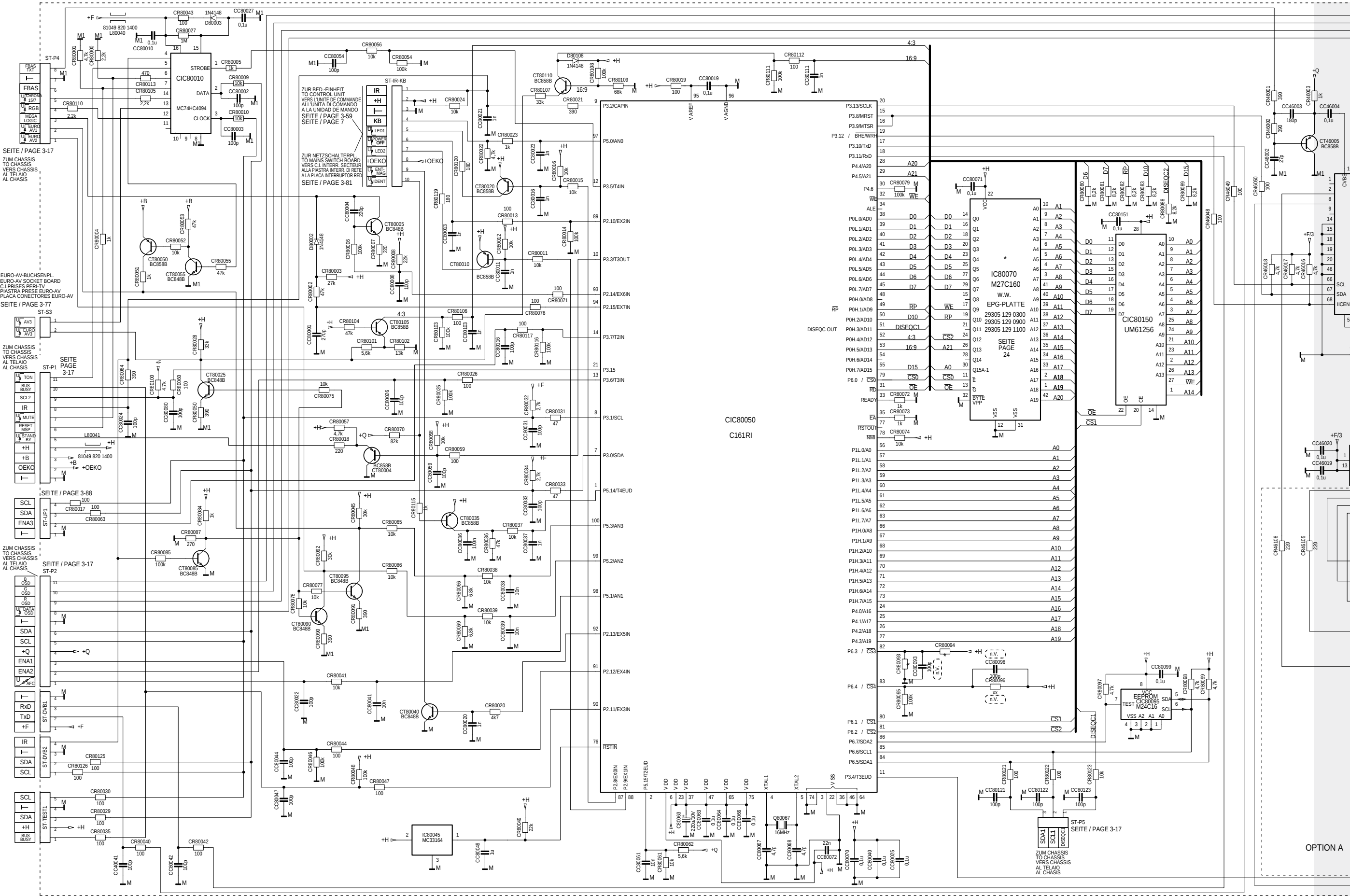


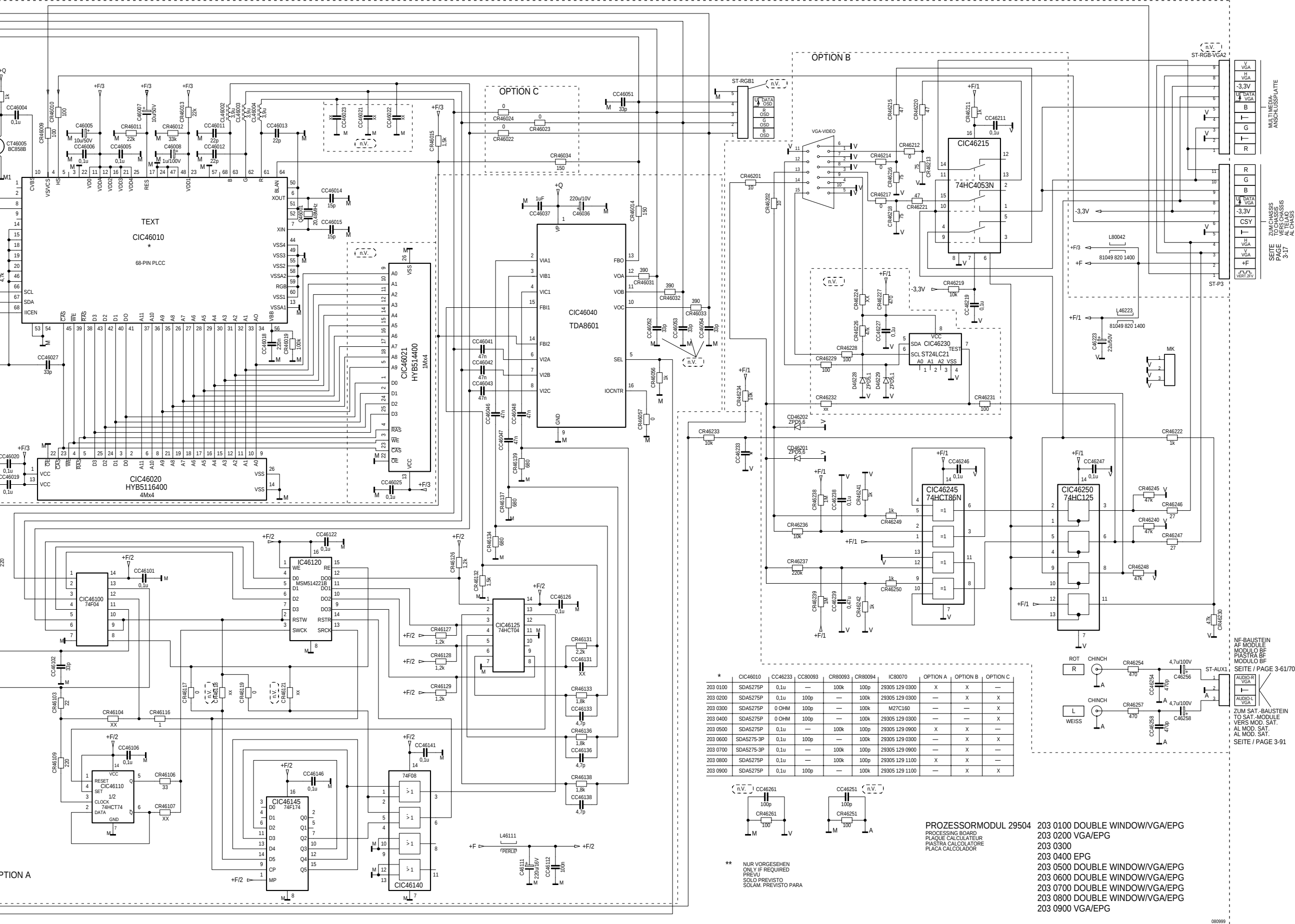
Prozessor-Modul / Processing Board 29504 203 0100 / 29504 203 0400 / 29504 203 0600
29504 203 0800 / 29504 203 0900

Spannungstabelle Table of Voltages							
+1	+12V	+4A	+5V	+B1	+12V	+E1	+8.5V
+2	+5V	+5	+5V	+C	+200V	+F	+5V
+3	+3.3V PAL/PLUS +5V LFR	+7	+12V	+D	+26V	+F/1	+5V
+4	+5V	+B	+12V	+E	+8.5V	+F/2	+5V

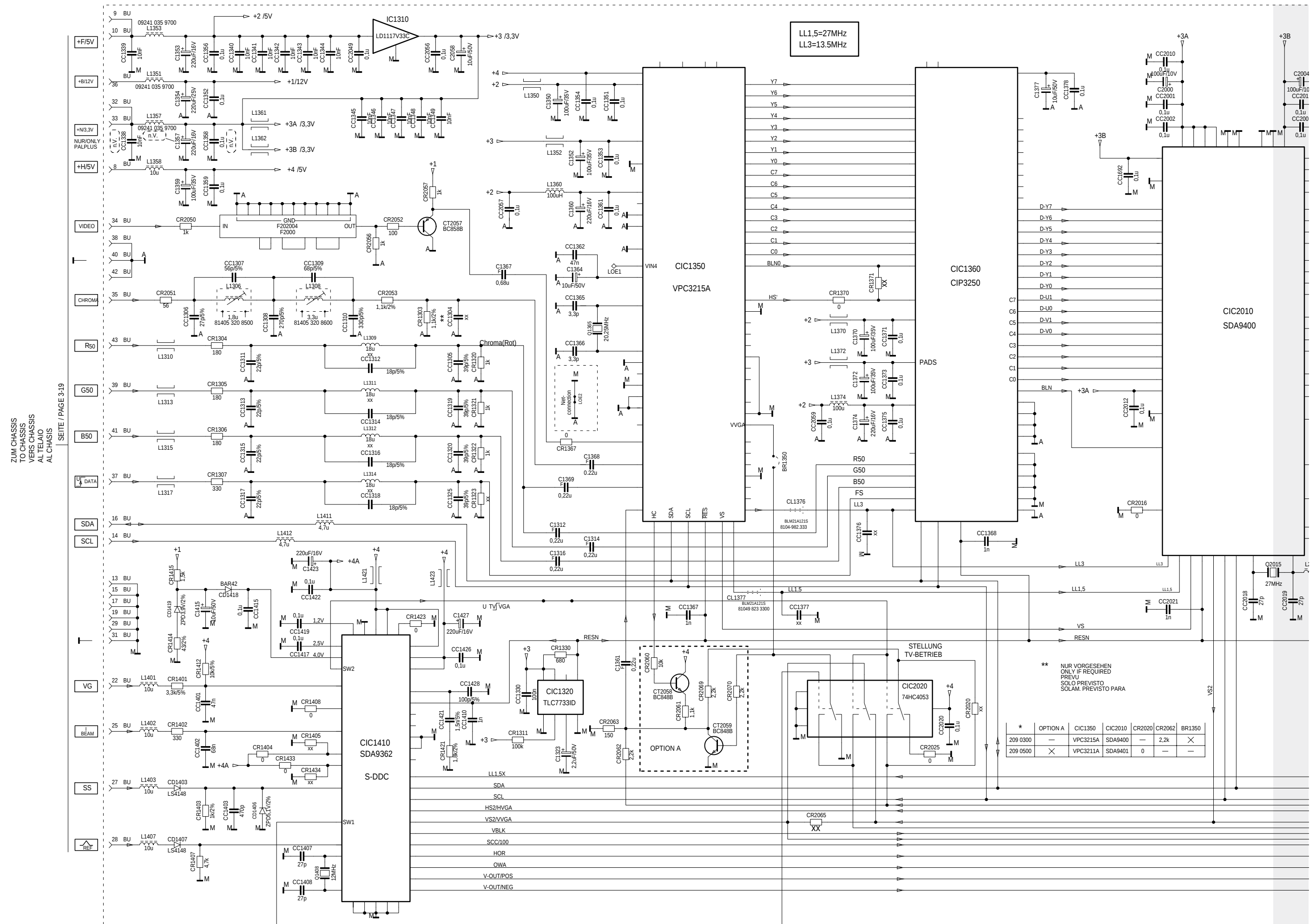


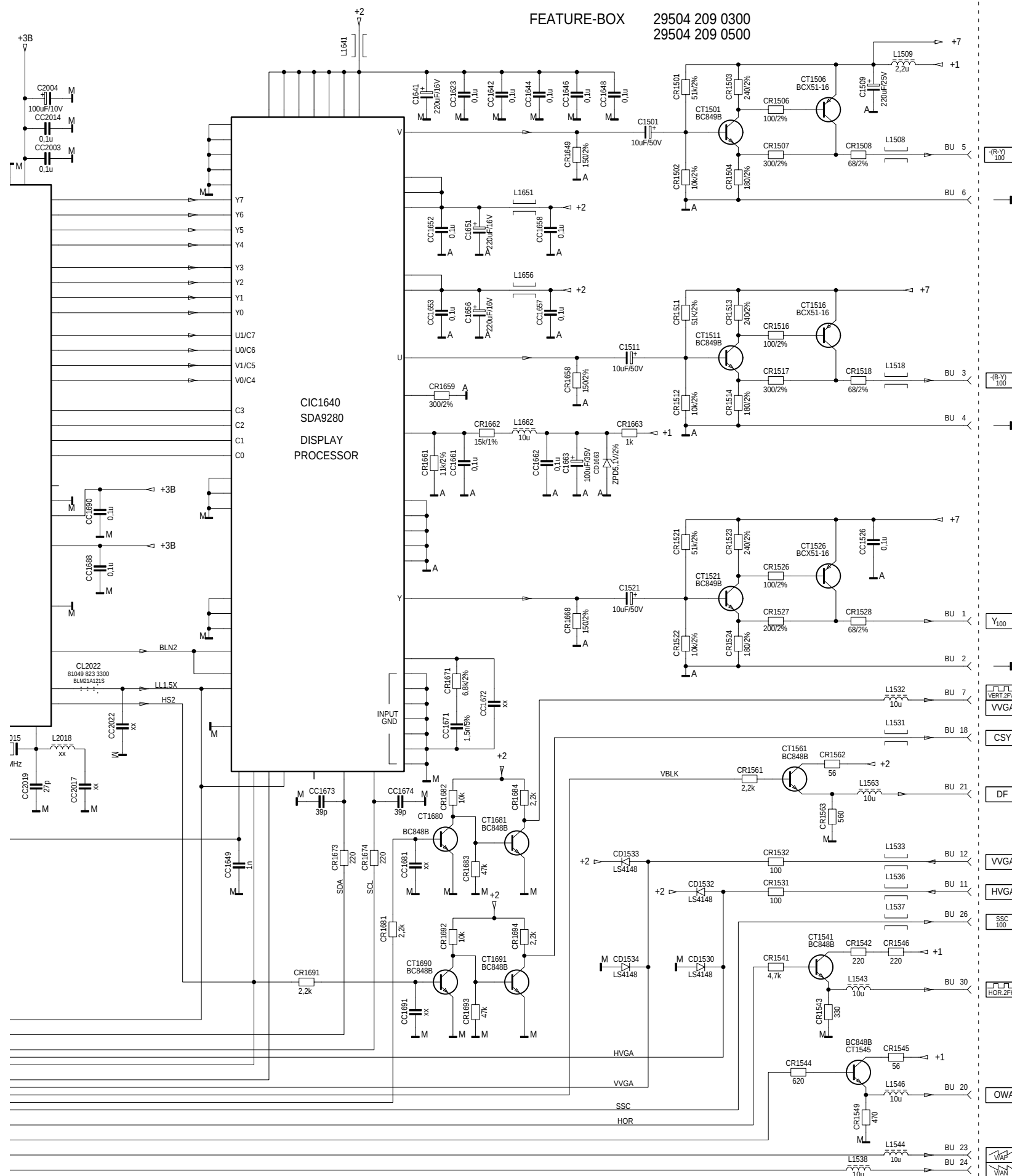
Spannungstabelle Table of Voltages							
+F/3	+5V	-G	-16.5V -13V CUC 1931 STATUS	+K	+13V	+Q	+8.5V
+G	+16.5V +13V CUC 1931 STATUS	-G/1	-16.5V -13V CUC 1931 STATUS	-K	-13V	+Q/1	+8.5V
+G/1	+16.5V +13V CUC 1931 STATUS	-G/2	-15.5V -12V CUC 1931 STATUS	+M	+16V	+Q/3	+8.5V
+G/2	+15.5V +12V CUC 1931 STATUS	+H	+5V	+N	+5V +3.3V PAL/PLUS	+OEKO	+9.5V - +14V

Bei den in den Schaltplänen angegebenen Messwerten handelt es sich um Näherungswerte!
The measured values given in the circuit diagrams are approximates!



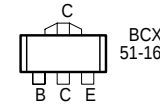
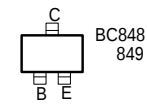
Feature Box 29504 209 0300 / 29504 209 0500





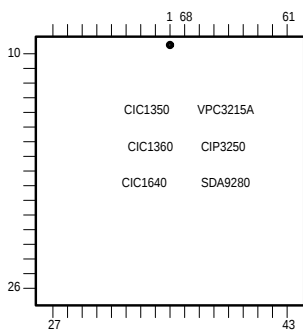
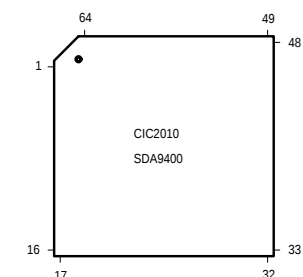
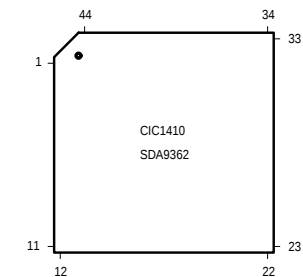
SEITE / PAGE 3-19

ZUM CHASSIS
TO CHASSIS
VERS CHASSIS
AL TELAIO
AL CHASSIS

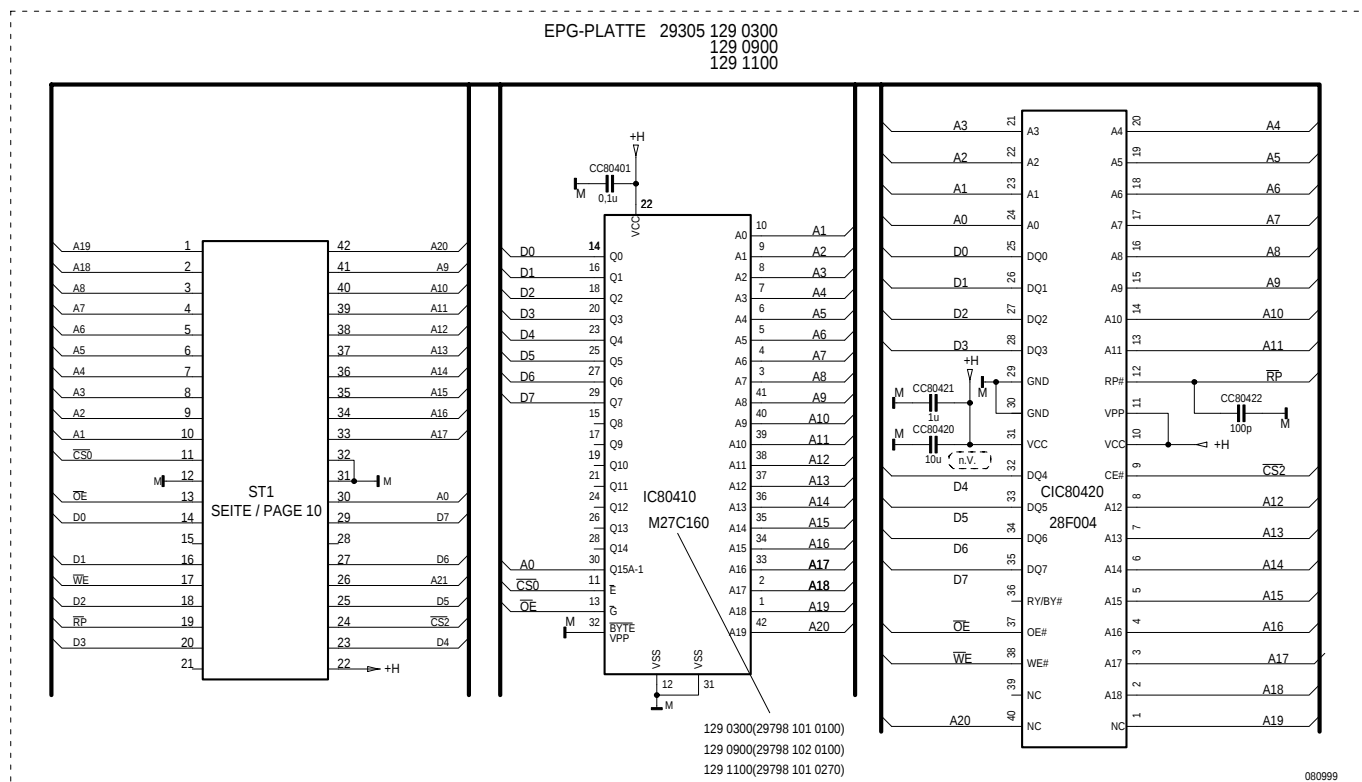
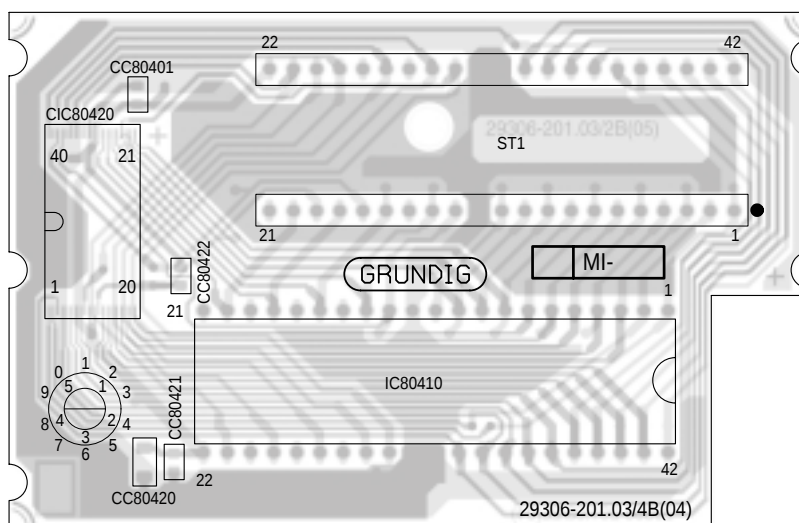
BCX
51-16BC848
849

IC VON OBEN
IC TOP VIEW
IC VUES DE DESSOUS
IC VEDUTO DA SOPRA
IC VISTO DESDE ARRIBA

	BU-
01	Y100 →
02	MASSE
03	·(B·Y)100 →
04	MASSE
05	·(R·Y)100 →
06	MASSE
07	VERT.2FV →
08	→ +H (+45V)
09	→ +F (+25V)
10	→ +Z (+25V)
11	→ HVGA
12	→ VVGA
13	MASSE
14	→ SCL
15	MASSE
16	→ SDA →
17	MASSE
18	CSY →
19	MASSE
20	OWA →
21	DF →
22	→ VG
23	 VIAP →
24	 VIAN →
25	→ IBEAM
26	SSC 100 →
27	→ SS
28	→ $\overline{\text{S}}_{\text{REF}}$
29	MASSE
30	HOR.2FV
31	MASSE
32	→ +N (+35V)
33	→ +N (+35V)
34	→ FBAS
35	CHROMA
36	→ +B (+1/12V)
37	 DATA 50
38	MASSE ANALOG
39	→ G50
40	MASSE ANALOG
41	→ B50
42	MASSE ANALOG
43	→ R50



EPG-Platte / EPG Board 29305 129 0300 / 29305 129 1100

Bestückungsseite, Ansicht von oben
Component Side, Top ViewLötseite, Ansicht von unten
Solder Side, Bottom View